

The size of the "process" indicates the minimum possible channel length.

Magnitude of the electron charge in the channel [Q]:

$$|Q| = C_{OX}(WL)v_{OV}$$

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 $\begin{array}{l} \epsilon_{OX} \text{ is the permittivity of the SiO}_2. \\ t_{OX} \text{ is the oxide thickness.} \\ \text{For } C_{OX} \text{ per micron squared, use} \\ C = C_{OX}WL \text{ [fF]} \end{array}$ 

$$i_D = \left[ (\mu_n C_{OX}) \left( \frac{W}{L} \right) (v_{GS} - V_t) \right] v_{DS}$$

$$i_D = [g_{DS}] v_{DS}$$

$$k_n' = \mu_n C_{OX}$$

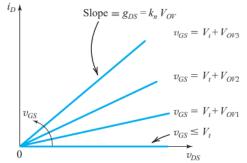
$$\kappa_n = \mu_n \cup_{OX}$$

$$k_n = k_n'(W/L)$$

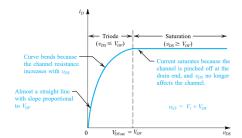
 $k_n^{'}$  is process transconductance paramter.  $k_n$  is device transconductance paramter.

When  $V_{DS}$  is small, the MOSFET behaves as a linear resistance  $r_{DS}$  whose value is controlled by the gate voltage  $v_{GS}$ 

$$r_{DS} = \frac{1}{g_{DS}}$$



Triode vs Saturation



$$\begin{aligned} & 0 & v_{\text{DSsss}} = v_{\text{OF}} \\ & \text{Triode} \ (v_{DS} \leq V_{OV}) \\ & i_D = k_n' \left(\frac{W}{L}\right) \left(V_{OV} - \frac{1}{2}v_{DS}\right) v_{DS} \\ & i_D = k_n' \left(\frac{W}{L}\right) \left[(v_{GS} - V_t)v_{DS} - \frac{1}{2}v_{DS}^2\right] \end{aligned}$$

Saturation  $(v_{DS} \ge V_{OV})$  $i_D = \frac{1}{2} k_n' \left(\frac{W}{L}\right) V_{OV}^2$ 

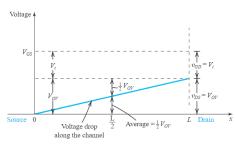
$$i_D = \frac{1}{2} k_n' \left(\frac{W}{L}\right) V_{OV}^2$$

 $k_n = k'_n$ , so

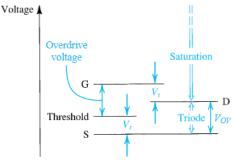
$$i_D = \frac{1}{2} k_n V_{OV}^2$$

Or.

$$i_D = \frac{1}{2}k_n(V_{GS}-V_{th})^2$$



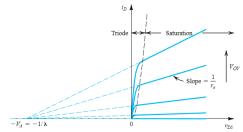
Constant  $V_{OV}$  can be replaced by variable  $v_{OV}$ . PMOS transistors operate similarly but the polarity is reversed, so  $v_{GS}$  must be negative and larger than a negative  $v_{tp}$ , as is  $v_{DS}$  negative.



If you care about **channel-length modulation**, then use the expression:

$$i_D = \frac{1}{2} k_n' \left(\frac{W}{L}\right) \left(v_{GS} - V_{th}\right)^2 (1 + \lambda v_{DS})$$

 $\begin{array}{cccc} & 2 & \backslash & L & / \\ v_{DS} = -\frac{1}{\lambda} \mid V_A = \frac{1}{\lambda} \mid V_A = V_A^{\prime} L \\ V_A & \text{(Early Voltage) has units of volts.} \\ V_A^{\prime} & \text{has units of volts per micron.} \end{array}$ 



Expression for  $r_o$ :

$$r_o = \frac{V_A}{I_D} = \frac{1}{\lambda I_D}$$

$$I_D = \frac{1}{2} k_n' \frac{W}{I} (V_{GS} - V_{tn})^2$$

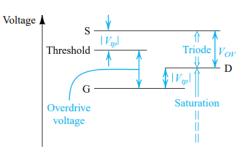
 $r_o = \frac{V_A}{I_D} = \frac{1}{\lambda I_D}$   $I_D \text{ is the drain current without channel-length modulation taken into account.}$   $I_D = \frac{1}{2} k_n' \frac{V}{L} (V_{GS} - V_{tn})^2$  For a p-Channel MOSFET, everything is backwards, here is an equation showing the voltages without negative signs, everything here is considered in terms of positive voltages or magnitudes.  $i = \frac{1}{2} l_{sol}' (W)$ 

$$i_D = \frac{1}{2} k_p' \left(\frac{W}{L}\right) (v_{SG} - |V_{tp}|)^2 (1 + |\lambda| v_{SD})$$

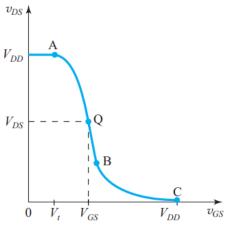
$$i_D = \frac{1}{2}k_p'\left(\frac{W}{L}\right)\left(v_{SG} - |V_{tp}|\right)^2\left(1 + \frac{v_{SD}}{|V_A|}\right)$$

$$R_D = \frac{V_{DD} - V_D}{I_D}$$

$$R_D = V_{DD} - I_D R_D$$



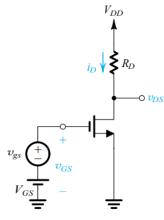
MOSFETs biased for linear amplification



Note bias point Q. Voltages  $V_{GS}$  and  $V_{DS}$  are related at the bias point by

$$v_{DS} = V_{DD} - \frac{1}{2}k_n R_D (v_{GS} - V_t)^2$$

$$v_{GS} = V_{GS} + v_{gs}$$



 $A_v$  is expressed in terms of  $V_{OV}$  at the bias point by

$$A_v = -k_n V_{OV} R_D$$

$$A_v = -\frac{2I_D R_D}{V_{OV}} = -\frac{I_D R_D}{V_{OV}/2}$$

To prevent nonlinear distortion,  $\boldsymbol{v}_{gs}$  must be sufficiently small.

$$v_{gs} \ll 2(V_{GS} - Vt)$$

$$v_{qs} \ll 2V_{OV}$$

When this condition is met, we can express  $i_D$  as:

$$i_D \simeq I_D + i_d$$
  
 $i_D V_{OV}^2$ 

Of course,  $I_D = \frac{1}{2}k_n V_{OV}^2$ and  $i_d = k_n (V_{GS} - V_t) v_{gs}$ 

$$g_m \equiv \frac{i_d}{v_{qs}} = k_n (V_{GS} - V_t)$$

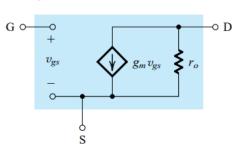
$$g_m = k_n V_{OV} = \mu_n C_{ox} \frac{W}{L} V_{OV}$$

$$g_m = k'_n(W/L)(V_{GS} - V_t) = k'_n(W/L)V_{OV}$$

$$g_m = \sqrt{2k'_n} \sqrt{W/L} \sqrt{I_D}$$

$$g_{m} = \frac{2I_{D}}{V_{GS} - V_{t}} = \frac{2I_{D}}{V_{OV}} = \sqrt{2\mu_{n}C_{ox}\frac{W}{L}I_{D}}$$

Small Signal Model



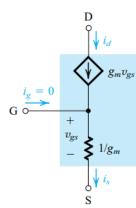
$$\begin{split} r_o &= \frac{|V_A|}{I_D} = \frac{1}{\lambda I_D} \mid A_v = \frac{v_{ds}}{v_{gs}} = -g_m(R_D \parallel r_o) \\ v_{DS} &= V_{DD} - R_D i_D \end{split}$$

$$v_{DS} = V_{DD} - R_D(I_D + i_d) = V_{DS} - R_D i_d$$

$$v_{DS} = -i_d R_D = -g_m v_{gs} R_D$$

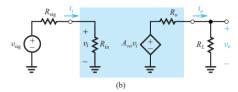
$$A_v \equiv \frac{v_{ds}}{v_{gs}} = -g_m R_D$$

T Equivalent-Circuit Model



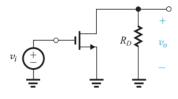
$$i_d = i_s = g_m v_{gs}$$

Characterizing Amplifiers



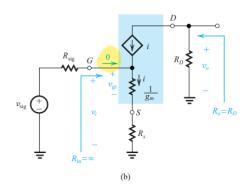
$$A_{vo} \equiv \frac{v_o}{v_i} \Big|_{R_L = \infty}$$
 
$$A_v \equiv \frac{v_o}{v_i} = A_{vo} \frac{R_L}{R_L + R_o}$$
 
$$G_v \equiv \frac{v_o}{v_{\text{sig}}}$$

Basic circuit configurations



(a) Common Source (CS)

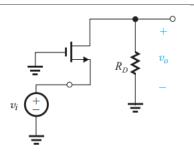
$$\begin{split} R_{\text{in}} &= \infty \mid v_o = -(g_m v_{gs})(R_D \parallel r_o) \\ A_{vo} &= -g_m(R_D \parallel r_o) \\ A_v &= G_v = -g_m(R_D \parallel R_L \parallel r_o) \\ v_{\text{sig}} \text{ must be much smaller than } 2V_{OV} \end{split}$$



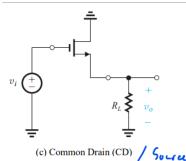
$$v_{gs} = \frac{v_i}{1 + g_m R_s}$$
 
$$v_o = -iR_D$$
 
$$i = \frac{v_i}{1/g_m + R_s} = \left(\frac{g_m}{1 + g_m R_s}\right) v_i$$

Those two together make:

$$A_{vo} = \frac{v_o}{v_i} = -\frac{R_D}{1/g_m + R_s}$$
 
$$A_v = -\frac{R_D \parallel R_L}{1/g_m + R_s}$$



$$\begin{split} R_{\rm in} &= \frac{1}{g_m} \mid i = -\frac{v_i}{1/g_m} \mid v_o = -iR_D \\ A_{vo} &\equiv \frac{v_o}{v_i} = g_m R_D \\ G_v &= \frac{(R_D \parallel R_L)}{R_{\rm sig} + 1/g_m} \end{split}$$



Often used as a voltage buffer so that the signal isn't attenuated at the output.

$$R_{\rm in} = \infty \mid A_{vo} = 1 \mid R_o = 1/g_m$$

$$G_v = A_v = \frac{R_L}{R_L + 1/g_m}$$

Biasing amplifier circuits Fixing  $V_G$  and using  $R_s$ , use  $V_G = V_{GS} + R_s I_D$